NCP59300, NCV59300 Series

3.0 A, Very Low-Dropout (VLDO) Fast Transient Response Regulator series

The NCP59300 series are high precision, very low dropout (VLDO), low ground current positive voltage regulators that are capable of providing an output current in excess of 3.0 A with a typical dropout voltage lower than 300 mV at 3.0 A load current. The devices are stable with ceramic output capacitors. This series consists of fixed voltage versions.

The NCP59300 series can withstand up to 18 V max input voltage.

Internal protection features consist of output current limiting, built−in thermal shutdown and reverse output current protection. Logic level enable and error flag pins are available on the 5−pin version.

The NCP59300 series fixed voltage devices are available in D2PAK−5 package, with devices in D2PAK−3 package planned in the future.

Features

- Output Current in Excess of 3.0 A
- 300 mV Typical Dropout Voltage at 3.0 A
- Fixed Output Voltage Options
- Low Ground Current
- Fast Transient Response
- Stable with Ceramic Output Capacitor
- Logic Compatible Enable and Error Flag Pins
- Current Limit, Reverse Current and Thermal Shutdown Protection
- Operation up to 13.5 V Input Voltage
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable
- These are Pb−Free Devices

Applications

- Consumer and Industrial Equipment Point of Regulation
- Servers and Networking Equipment
- FPGA, DSP and Logic Power supplies
- Switching Power Supply Post Regulation
- Battery Chargers
- Functional Replacement for Industry Standard MIC29300, MIC39300, MIC37300 Fixed Voltage Devices

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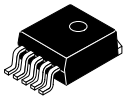
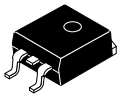


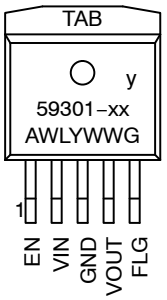
D²PAK 5
CASE 936A



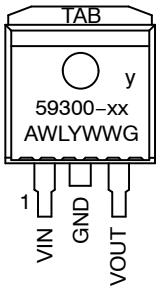
D²PAK
CASE 936

MARKING DIAGRAMS

D²PAK



D²PAK3



xx	= Voltage Version
y	= P (NCP), V (NCV)
A	= Assembly Location
WL	= Wafer Lot
Y	= Year
WW	= Work Week
G	= Pb−Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

TYPICAL APPLICATIONS

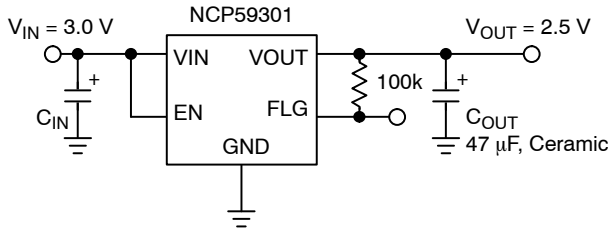


Figure 1. Fixed 2.5 V Regulator with Error Flag

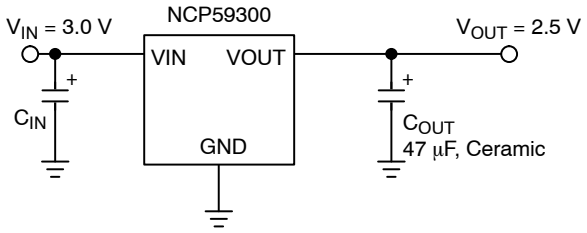


Figure 2. Fixed 2.5 V Regulator in D²PAK−3 Package

PIN FUNCTION DESCRIPTION

Pin Number D2PAK−5	Pin Number D2PAK−3	Pin Name	Pin Function
1	−	EN	Enable Input: CMOS and TTL logic compatible. Logic high = enable; Logic low = shutdown.
2	1	VIN	Input voltage which supplies both the internal circuitry and the current to the output load
3	2	GND	Ground
TAB	TAB	TAB	TAB is connected to ground.
4	3	VOUT	Linear Regulator Output.
5	−	FLG	Error Flag Open collector output. Active−low indicates an output fault condition.

ABSOLUTE MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V_{IN}	Supply Voltage	0 to 18	V
V_{EN}	Enable Input Voltage	0 to 18	V
V_{FLG}	Error Flag Open Collector Output Maximum Voltage	0 to 18	V
$V_{OUT} - V_{IN}$	Reverse $V_{OUT} - V_{IN}$ Voltage (EN = Shutdown or V_{IN} = 0 V) (Note 1)	0 to 6.5	V
P_D	Power Dissipation (Notes 2 and 3)	Internally Limited	
T_J	Junction Temperature	$-40 \le T_J \le +125$	°C
T_S	Storage Temperature	$-65 \le T_J \le +150$	°C
	ESD Rating (Notes 4 and 5) Human Body Model Machine Model	2000 200	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: All voltages are referenced to GND pin unless otherwise noted.

1. The ENABLE pin input voltage must be ≤ 0.8 V or V_{IN} must be connected to ground potential.
2. $P_{D(max)} = (T_{J(max)} - T_A) / R_{\theta JA}$, where $R_{\theta JA}$ depends upon the printed circuit board layout.
3. This protection is not guaranteed outside the Recommended Operating Conditions.
4. Devices are ESD sensitive. Handling precautions recommended..
5. This device series incorporates ESD protection and is tested by the following methods:
   ESD Human Body Model (HBM) tested per AEC − Q100 − 002 (EIA/JESD22 − A114C)
   ESD Machine Model (MM) tested per AEC − Q100 − 003 (EIA/JESD22 − A115C)
   This device contains latch − up protection and exceeds 100 mA per JEDEC Standard JESD78.

RECOMMENDED OPERATING CONDITIONS (Note 6)

Symbol	Rating	Value	Unit
V_{IN}	Supply Voltage	2.24 to 13.5	V
V_{EN}	Enable Input Voltage	0 to 13.5	V
V_{FLG}	Error Flag Open Collector Voltage	0 to 13.5	V
T_J	Junction Temperature	$-40 \le T_J \le +125$	°C

6. The device is not guaranteed to function outside it's Recommended operating conditions.

ELECTRICAL CHARACTERISTICS

(T_J = 25°C with $V_{IN} = V_{OUT\ nominal}$ + 1 V; $V_{EN} = V_{IN}$; I_L = 10 mA; bold values indicate −40°C < T_J < +125°C, unless noted.)

Parameter	Conditions	Min	Typ	Max	Unit
Output Voltage Accuracy	I_L = 10 mA	−1.5		+1.5	%
	10 mA < I_{OUT} < 3 A , $V_{OUT\ nominal}$ + 1 ≤ V_{IN} ≤ 13.5 V	**−2.5**		**+2.5**	%
Output Voltage Line Regulation	$V_{IN} = V_{OUT\ nominal}$ + 1.0 V to 13.5 V; I_L = 10 mA		0.02	0.5	%
Output Voltage Load Regulation	I_L = 10 mA to 3 A		0.2	1	%
$V_{IN} - V_{OUT}$ Dropout Voltage (Note 7)	I_L = 1.5 A		175	**350**	mV
	I_L = 3 A		300	**500**	mV
Ground Pin Current (Note 8)	I_L = 3 A		60	90 **120**	mA
Ground Pin Current in Shutdown	V_{EN} ≤ 0.5 V		1.0	5	μA
Overload Protection Current Limit	V_{OUT} = 0 V		3.5	**5**	A
Output Voltage Start−up Slope	$V_{EN} = V_{IN}$, I_{OUT} = 10 mA, C_{OUT} = 47 μF (Note 9)		40	200	μs/V
ENABLE INPUT					
Enable Input Signal Levels	Regulator enable	**1.8**			V
	Regulator shutdown			**0.8**	V
Enable pin Input Current	V_{EN} ≤ 0.8 V (Regulator shutdown)			2 **4**	μA
	6.5 V > V_{EN} ≥ 1.8 V (Regulator enable)	1	15	30 **40**	μA
FLAG OUTPUT					
$I_{flg(leak)}$	V_{oh} = 6 V			1 **2**	μA
$V_{FLG(LO)}$	V_{IN} = 2.24 V, I_{FLG} = 250 μA		210	400 **500**	mV
V_{FLG}	Low Threshold, % of V_{OUT}	93	95		%
	Hysteresis		2		%
	High Threshold, % of V_{OUT}		97	99.2	%

7. $V_{DO} = V_{IN} - V_{OUT}$ when V_{OUT} decreases to 98% of its nominal output voltage with $V_{IN} = V_{OUT}$ + 1 V. For output voltages below 1.74 V, dropout voltage specification does not apply due to a minimum input operating voltage of 2.24 V.
8. $I_{IN} = I_{GND} + I_{OUT}$.
9. Fixed Voltage Device Start−up Time = Output Voltage Start−up Slope x V_{OUT} Nominal.

Package	Conditions / PCB Footprint	Thermal Resistance
D2PAK−3, Junction−to−Case		$R_{\theta JC}$ = 2.1°C/W
D2PAK−5, Junction−to−Case		$R_{\theta JC}$ = 2.1°C/W
D2PAK−3, Junction−to−Air	PCB with 100 mm^2 2.0 oz Copper Heat Spreading Area	$R_{\theta JA}$ = 52°C/W
D2PAK−5, Junction−to−Air	PCB with 100 mm^2 2.0 oz Copper Heat Spreading Area	$R_{\theta JA}$ = 52°C/W

TYPICAL CHARACTERISTICS

T_J = 25°C if not otherwise noted

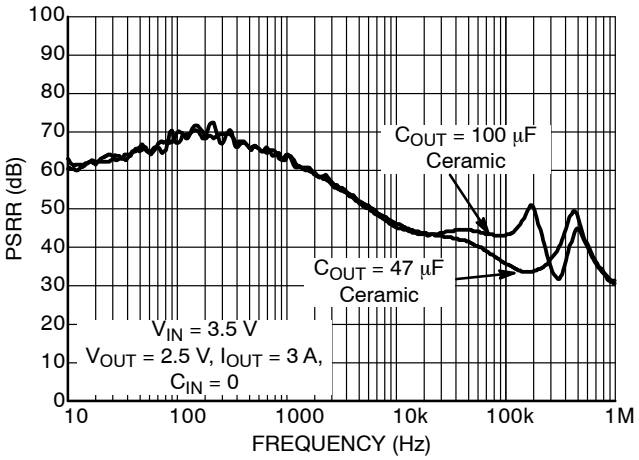


Figure 3. Power Supply Rejection Ratio

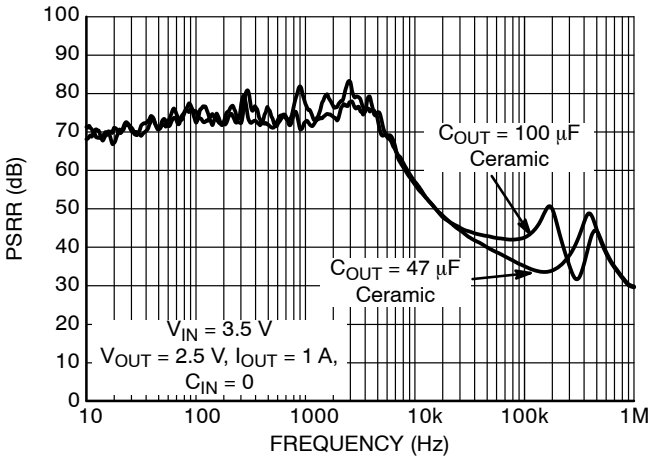


Figure 4. Power Supply Rejection Ratio

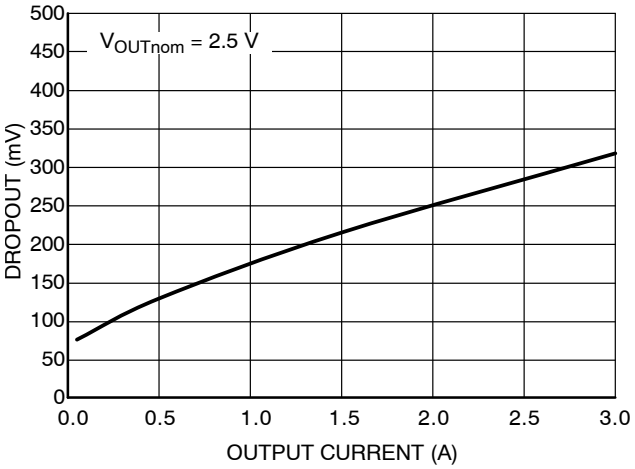


Figure 5. Dropout Voltage vs. Output Current

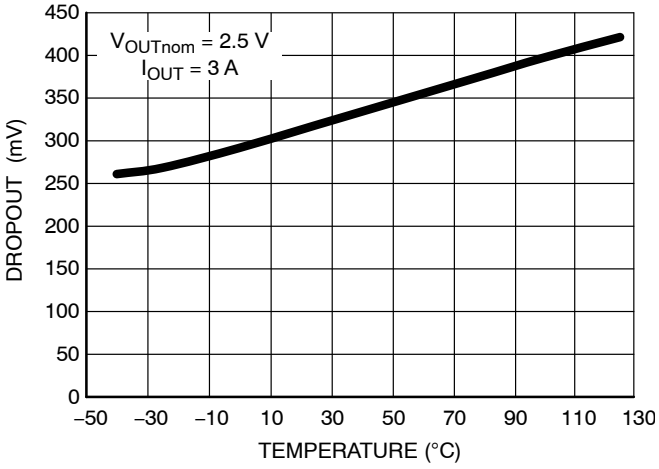


Figure 6. Dropout Voltage vs. Temperature

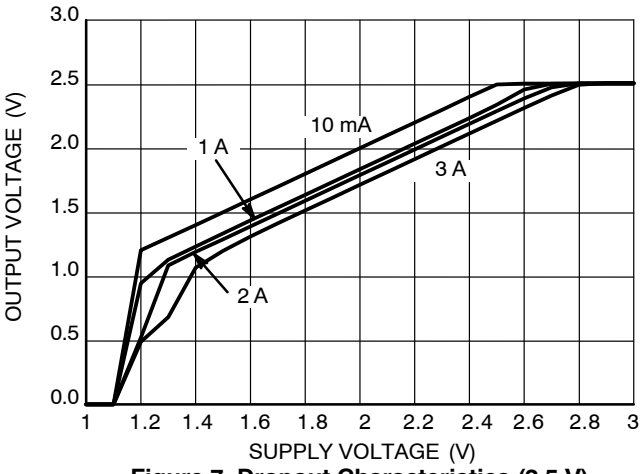


Figure 7. Dropout Characteristics (2.5 V)

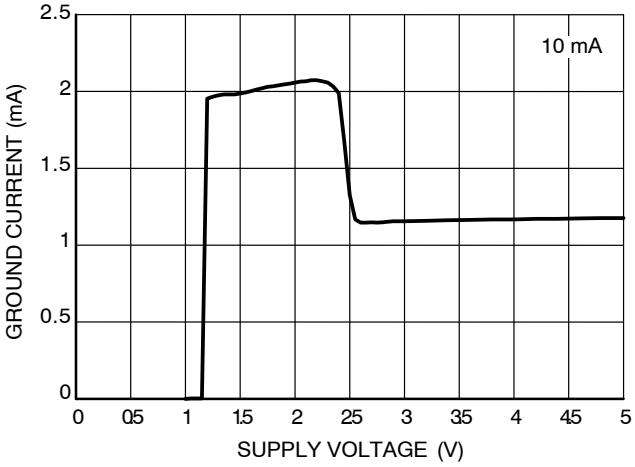


Figure 8. Ground Current vs. Supply Voltage (2.5 V)

TYPICAL CHARACTERISTICS

T_J = 25°C if not otherwise noted

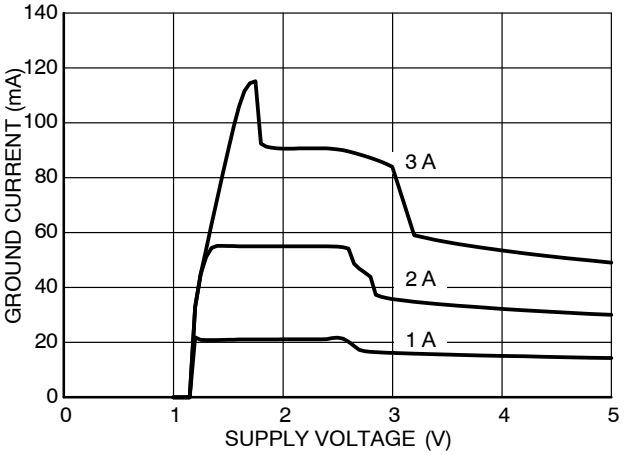


Figure 9. Ground Current vs. Supply Voltage (2.5 V)

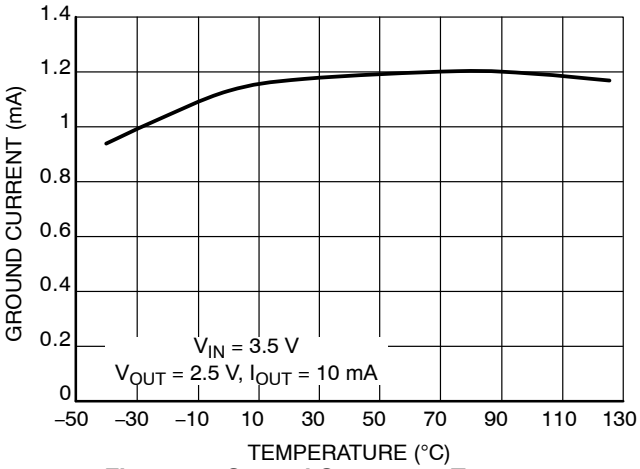


Figure 10. Ground Current vs. Temperature

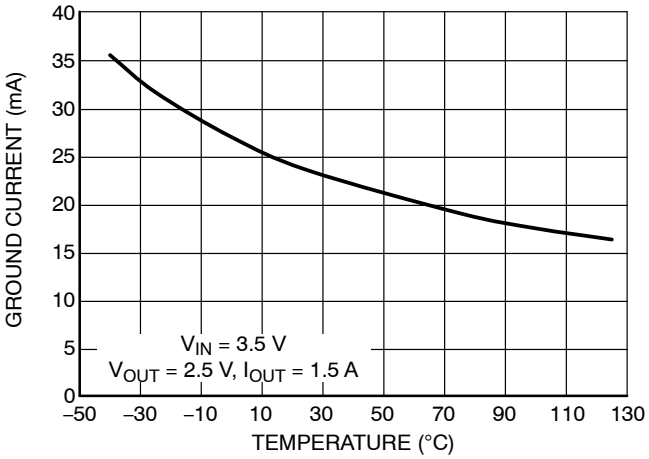


Figure 11. Ground Current vs. Temperature

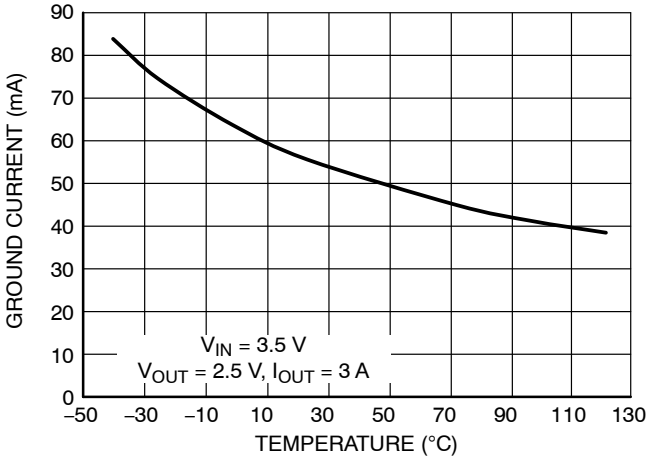


Figure 12. Ground Current vs. Temperature

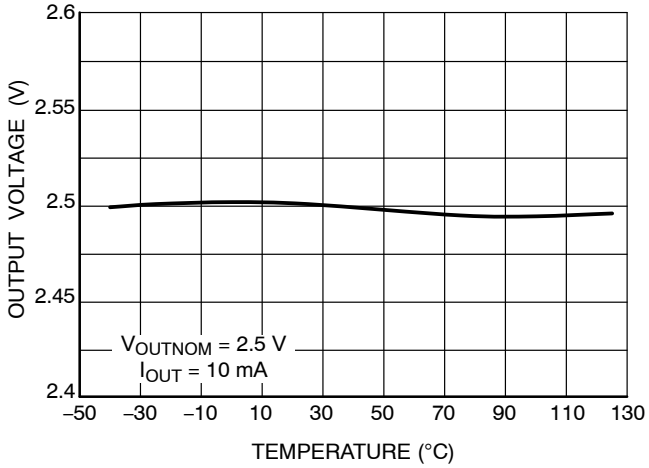


Figure 13. Output Voltage vs. Temperature

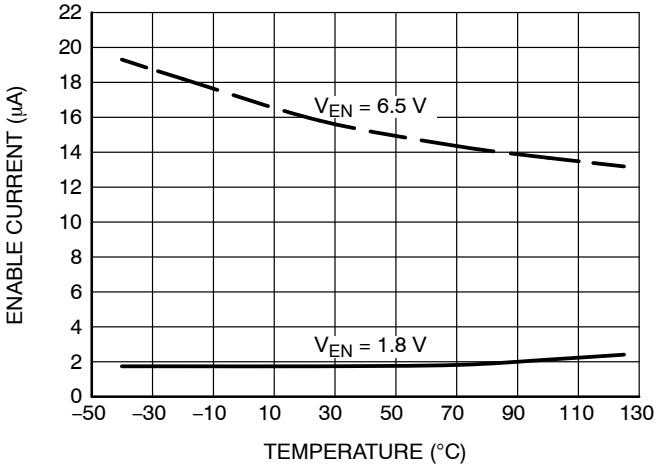


Figure 14. Enable Pin Input Current vs. Temperature

FUNCTIONAL CHARACTERISTICS

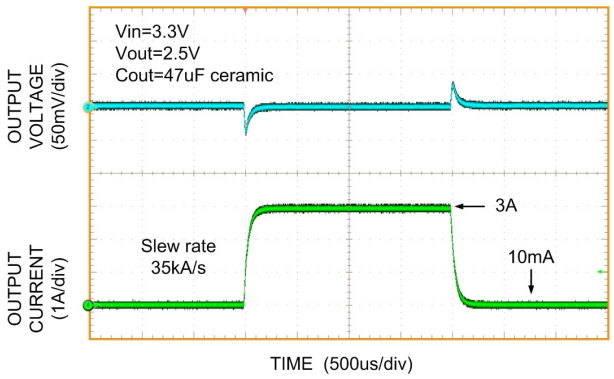


Figure 15. Load Transient Response

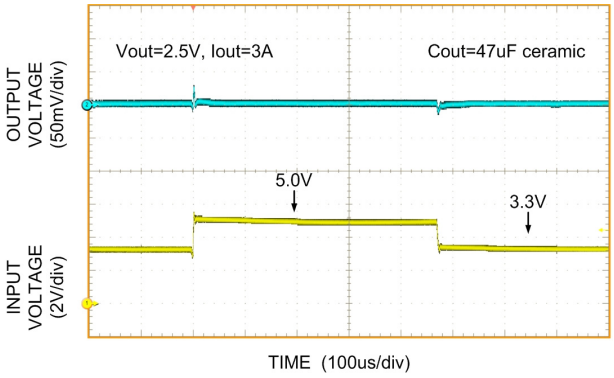


Figure 16. Line Transient Response

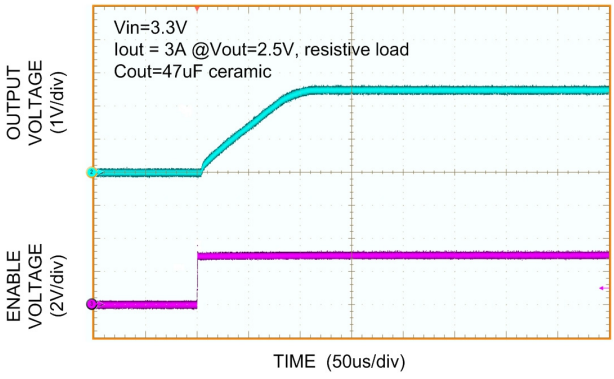


Figure 17. Enable Transient Response

APPLICATIONS INFORMATION

Output Capacitor and Stability

The NCP59300 series requires an output capacitor for stable operation. The NCP59300 series is designed to operate with ceramic output capacitors. The recommended output capacitance value is 47 μF or greater. Such capacitors help to improve transient response and noise reduction at high frequency.

Input Capacitor

An input capacitor of 1.0 μF or greater is recommended when the device is more than 4 inches away from the bulk supply capacitance, or when the supply is a battery. Small, surface−mount chip capacitors can be used for the bypassing. The capacitor should be place within 1 inch of the device for optimal performance. Larger values will help to improve ripple rejection by bypassing the input of the regulator, further improving the integrity of the output voltage.

Minimum Load Current

The NCP59300 regulator is specified between finite loads. A 10 mA minimum load current is necessary for proper operation.

Error Flag

Some NCP59300 series members feature an error flag circuit that monitors the output voltage and signals an error condition when the voltage is 5% below the nominal output voltage. The error flag is an open−collector output that can sink up to 5 mA typically during a V_{OUT} fault condition.

The FLG output is overload protected when a short circuit of the pullup load resistor occurs in the application. This is guaranteed in the full range of FLG output voltage Max ratings (see Max Ratings table). Please be aware operation in this mode is not recommended, power dissipated in the device can impact on output voltage precision and other device characteristics.

Enable Input

Some NCP59300 series members also feature an enable input for on/off control of the device. It's shutdown state draws "zero" current from input voltage supply (only microamperes of leakage). The enable input is TTL/CMOS compatible for simple logic interface, but can be connected up to V_{IN}.

Overcurrent and Reverse Output Current Protection

The NCP59300 regulator is fully protected from damage due to output current overload conditions. When NCP59300 output is overloaded, Output Current limiting is provided. This limiting is linear; output current during overload conditions is constant. These features are advantageous for powering FPGAs and other ICs having current consumption higher than nominal during their startup.

Thermal shutdown disables the NCP59300 device when the die temperature exceeds the maximum safe operating temperature.

When NCP59300 is disabled and ($V_{OUT} - V_{IN}$) voltage difference is less than 6.5 V in the application, the output structure of these regulators is able to withstand output voltage (backup battery as example) to be applied without reverse current flow. Of course the additional current flowing through the Feedback resistor divider inside the NCP59300 Fixed voltage devices (30 μA typically at nominal output voltage) needs to be included in the backup battery discharging calculations.

Thermal Considerations

The power handling capability of the device is limited by the maximum rated junction temperature (125°C). The P_D total power dissipated by the device has two components, Input to output voltage differential multiplied by Output current and Input voltage multiplied by GND pin current.

$$P_D = \left(V_{IN} - V_{OUT}\right) \cdot I_{OUT} + V_{IN} \cdot I_{GND} \quad \text{(eq. 1)}$$

The GND pin current value can be found in Electrical Characteristics table and in Typical Characteristics graphs.

The Junction temperature T_J is

$$T_J = T_A + P_D \cdot R_{\theta JA} \quad \text{(eq. 2)}$$

where T_A is ambient temperature and $R_{\theta JA}$ is the Junction to Ambient Thermal Resistance of the NCP/NCV59300 device mounted on the specific PCB.

To maximize efficiency of the application and minimize thermal power dissipation of the device it is convenient to use the Input to output voltage differential as low as possible.

The static typical dropout characteristics for various output voltage and output current can be found in the Typical Characteristics graphs.

ORDERING INFORMATION

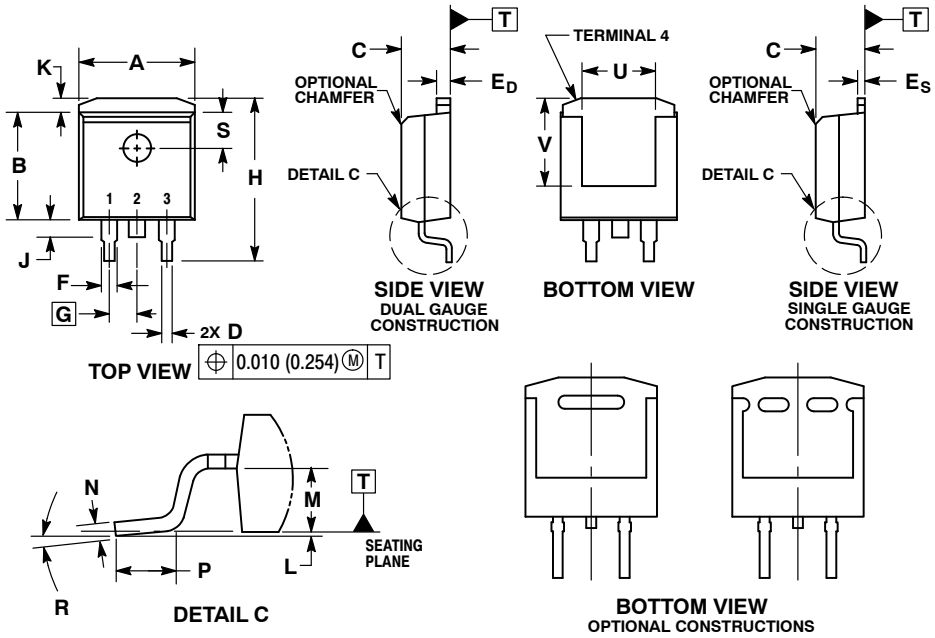
Device	Output Current	Output Voltage	Junction Temp. Range	Package	Shipping†
NCP59300DS18R4G	3.0 A	1.8 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCP59300DS25R4G	3.0 A	2.5 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCP59300DS28R4G	3.0 A	2.8 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCP59300DS30R4G	3.0 A	3.0 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCP59300DS33R4G	3.0 A	3.3 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCP59300DS50R4G	3.0 A	5.0 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCV59300DS18R4G*	3.0 A	1.8 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCV59300DS25R4G*	3.0 A	2.5 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCV59300DS28R4G*	3.0 A	2.8 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCV59300DS30R4G*	3.0 A	3.0 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCV59300DS33R4G*	3.0 A	3.3 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCV59300DS50R4G*	3.0 A	5.0 V	−40°C to +125°C	D2PAK−3 (Pb−Free)	Under Development Contact Sales Office
NCP59301DS18R4G	3.0 A	1.8 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59301DS25R4G	3.0 A	2.5 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59301DS28R4G	3.0 A	2.8 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59301DS30R4G	3.0 A	3.0 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59301DS33R4G	3.0 A	3.3 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59301DS50R4G	3.0 A	5.0 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59301DS18R4G*	3.0 A	1.8 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59301DS25R4G*	3.0 A	2.5 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59301DS28R4G*	3.0 A	2.8 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59301DS30R4G*	3.0 A	3.0 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59301DS33R4G*	3.0 A	3.3 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59301DS50R4G*	3.0 A	5.0 V	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable.

PACKAGE DIMENSIONS

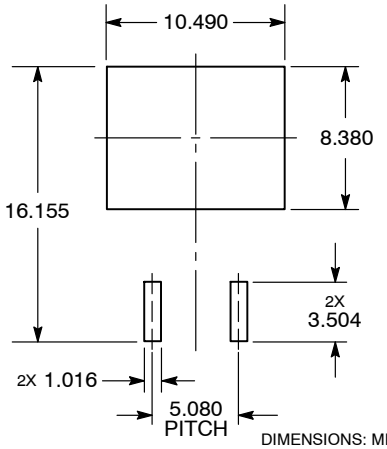
D²PAK
CASE 936−03
ISSUE D



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCHES.
3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 4.
5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.
6. SINGLE GAUGE DESIGN WILL BE SHIPPED AFTER FPCN EXPIRATION IN OCTOBER 2011.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.386	0.403	9.804	10.236
B	0.356	0.368	9.042	9.347
C	0.170	0.180	4.318	4.572
D	0.026	0.036	0.660	0.914
E_D	0.045	0.055	1.143	1.397
E_S	0.018	0.026	0.457	0.660
F	0.051 REF		1.295 REF	
G	0.100 BSC		2.540 BSC	
H	0.539	0.579	13.691	14.707
J	0.125 MAX		3.175 MAX	
K	0.050 REF		1.270 REF	
L	0.000	0.010	0.000	0.254
M	0.088	0.102	2.235	2.591
N	0.018	0.026	0.457	0.660
P	0.058	0.078	1.473	1.981
R	5° REF		5° REF	
S	0.116 REF		2.946 REF	
U	0.200 MIN		5.080 MIN	
V	0.250 MIN		6.350 MIN	

SOLDERING FOOTPRINT*

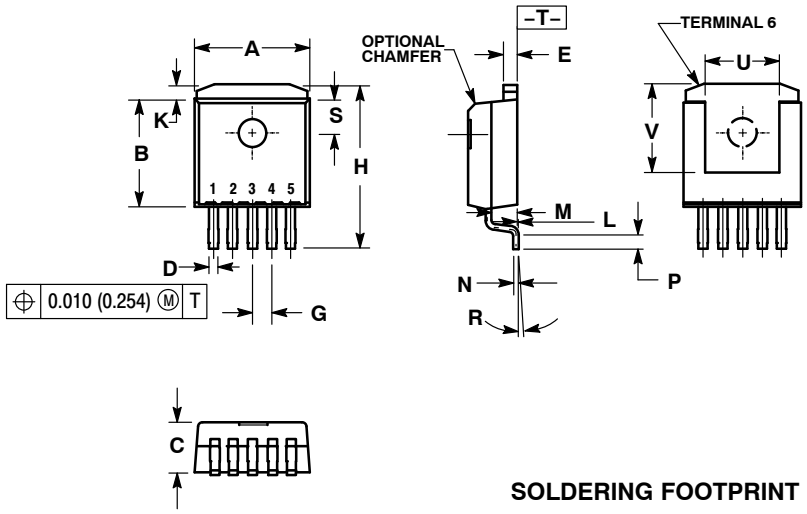


DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

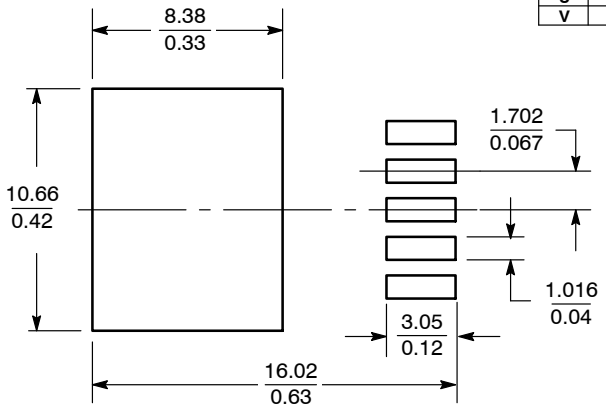
D²PAK 5
CASE 936A−02
ISSUE C



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 6.
5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.386	0.403	9.804	10.236
B	0.356	0.368	9.042	9.347
C	0.170	0.180	4.318	4.572
D	0.026	0.036	0.660	0.914
E	0.045	0.055	1.143	1.397
G	0.067 BSC		1.702 BSC	
H	0.539	0.579	13.691	14.707
K	0.050 REF		1.270 REF	
L	0.000	0.010	0.000	0.254
M	0.088	0.102	2.235	2.591
N	0.018	0.026	0.457	0.660
P	0.058	0.078	1.473	1.981
R	5° REF		5° REF	
S	0.116 REF		2.946 REF	
U	0.200 MIN		5.080 MIN	
V	0.250 MIN		6.350 MIN	

SOLDERING FOOTPRINT



SCALE 3:1 $\left(\frac{mm}{inches}\right)$

5−LEAD D²PAK

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